PARA LIGHT ELECTRONICS CO., LTD.
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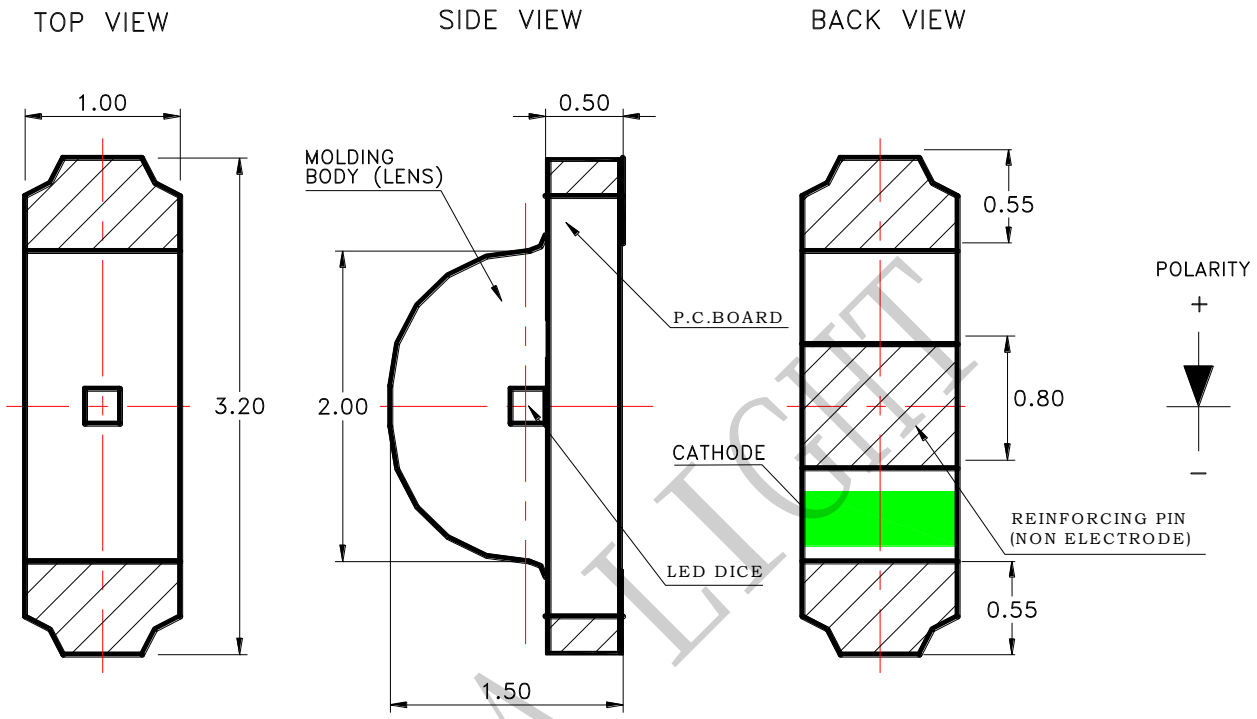
DATA SHEET

PART NO.: L-S110JFCT

REV: A / 0

CUSTOMER'S APPROVAL : _____ DCC : _____

PACKAGE OUTLINE DIMENSIONS



Notes:

1. All dimensions are in millimeters.
2. Tolerance is ± 0.1mm (.004") unless otherwise noted.

Features

- ✳ Side looking special for LCD backlight.
- ✳ Package in 8mm tape on 7" diameter reels.
- ✳ Compatible with automatic Pick & Place equipment.
- ✳ Compatible with Infrared and Wave soldering reflow solder processes.
- ✳ EIA STD package.
- ✳ I.C. compatible.
- ✳ Pb free product.
- ✳ Meet RoHS Green Product.
- ✳ Moisture sensitivity level: 3

Chip Materials

- ＊ Dice Material : AlInGaP
- ＊ Light Color : Super Amber
- ＊ Lens Color : Water Clear

Absolute Maximum Ratings(Ta=25℃)

Symbol	Parameter	Rating	Unit
P_D	Power Dissipation	75	mW
I_{PF}	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	mA
I_F	Continuous Forward Current	25	mA
V_R	Reverse Voltage	5	V
Topr	Operating Temperature Range	-40 ~ +85	℃
Tstg	Storage Temperature Range	-40 ~ +85	℃

Electro-Optical Characteristics(Ta=25℃)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	71	120		mcd	IF=20mA
Viewing Angle	2θ1/2		130		deg	Note 2
Peak Emission Wavelength	λp		611		nm	Measurement @Peak
Dominant Wavelength	λd		605		nm	IF=20mA
Spectral Line Half-Width	Δλ		17		nm	
Forward Voltage	VF		2.0	2.4	V	IF =20mA
Reverse Current	IR			10	μA	VR = 5V

- Bin Code List

Luminous Intensity(IV), Unit:mcd@20mA		
Bin Code	Min	Max
Q	71	112
R	112	180

Tolerance of each bin are±15%

Notes:

1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
2. θ1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
4. Caution in ESD :
   Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

● Typical Electro-Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

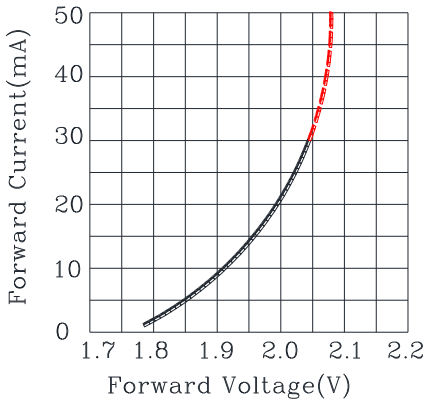


Fig.2 Forward Current vs.Forward Voltage

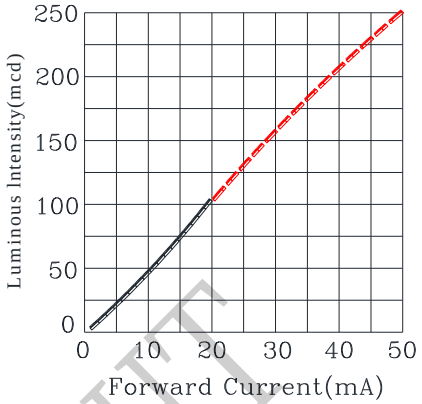


Fig.3 Luminous Intensity vs.Forward Current

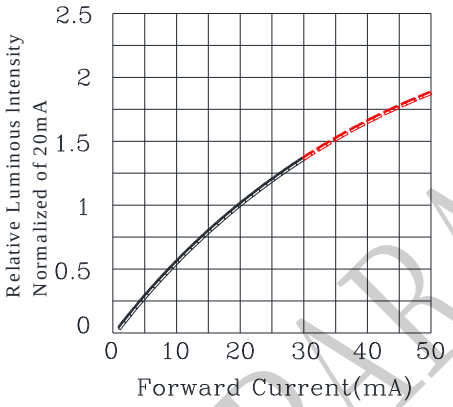


Fig.4 Relative Luminous Intensity vs.Forward Current

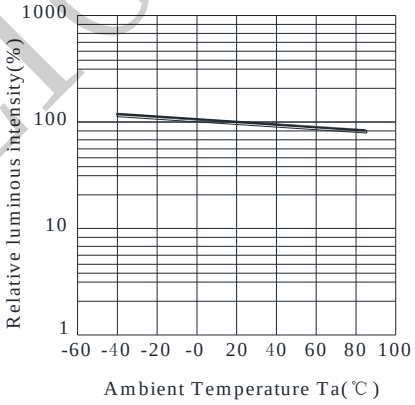


Fig.5 Luminous Intensity vs.Ambient Temperature

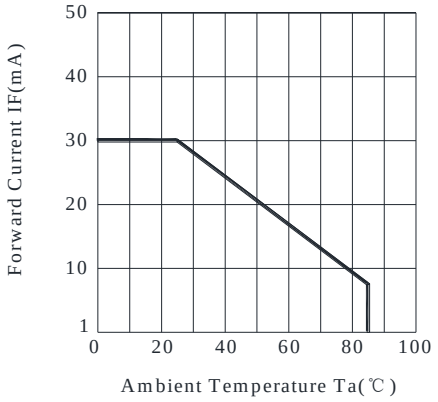


Fig.6 Forward Current Derating Curve

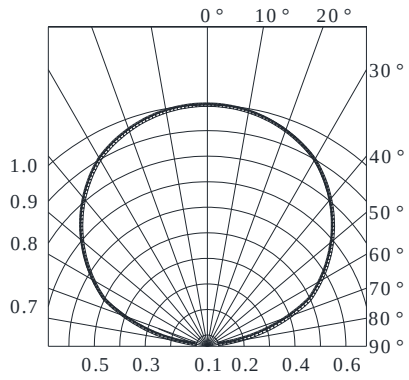


Fig.7 Relative Intensity vs.Angle

Label Explanation

ITEM CODE:PARRA LIGHT

PART NO: L-S110JFCT

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110

A B C D E F

A---EM: Emos Code

B---S:SMD

L---Local

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG :

3000pcs for 150、170、110、155、115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE：2012 09 10

G H I

G--- Year

H--- Month

I --- Day

- Typical Electro-Optical Characteristics Curves

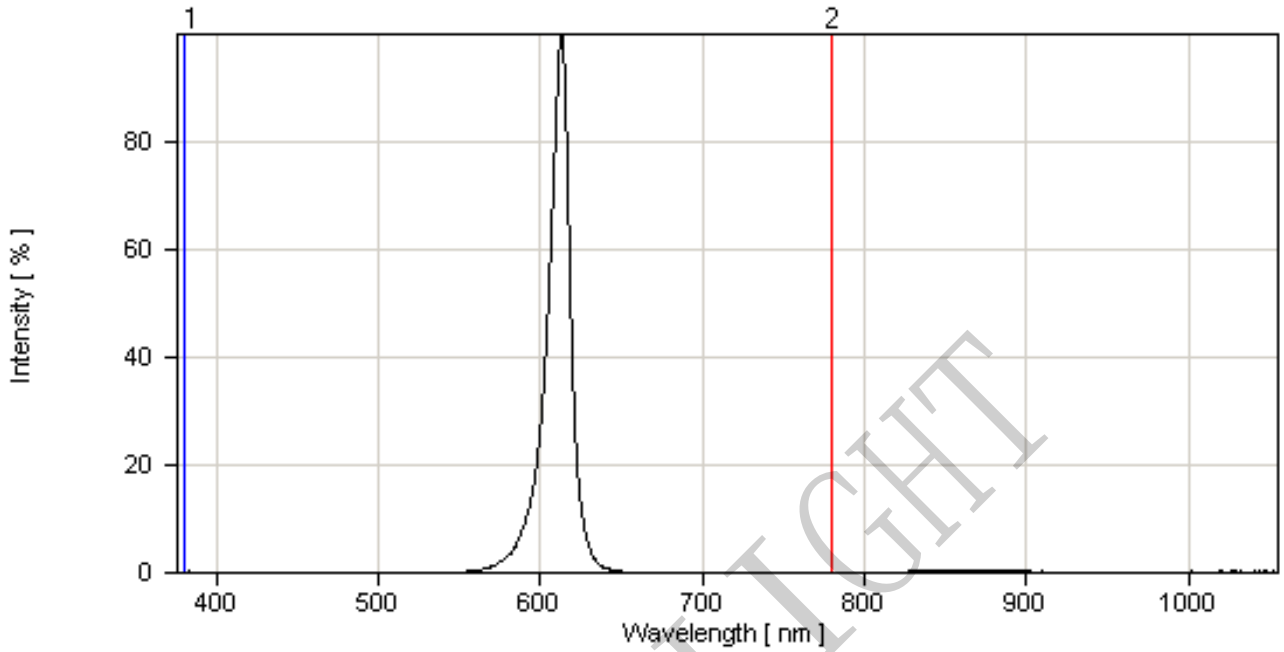
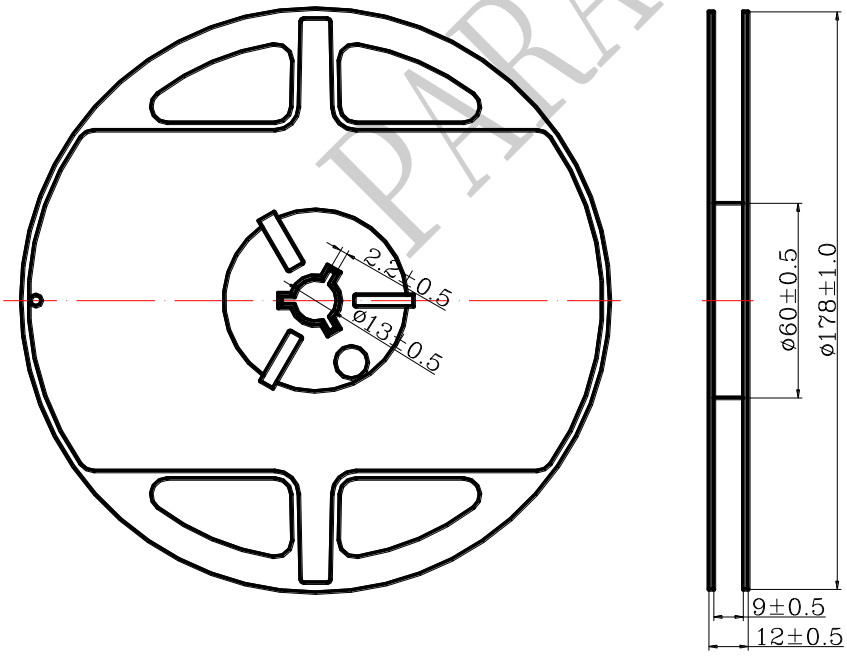


Fig.1 Relative Intensity vs. Wavelength

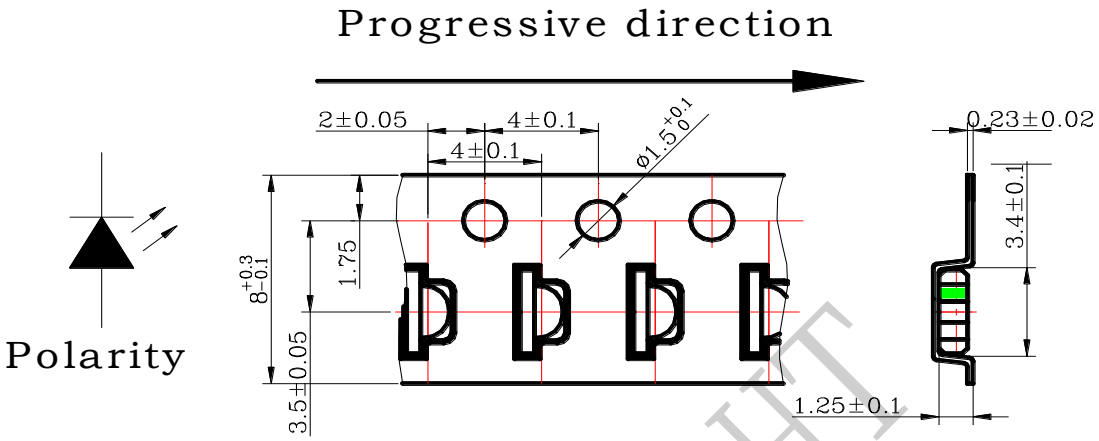
- Reel Dimensions



Notes:

1. Taping Quantity : 3000pcs
2. The tolerances unless mentioned is ±0.1mm, Angle ±0.5° , Unit : mm.

- Package Dimensions Of Tape And Reel

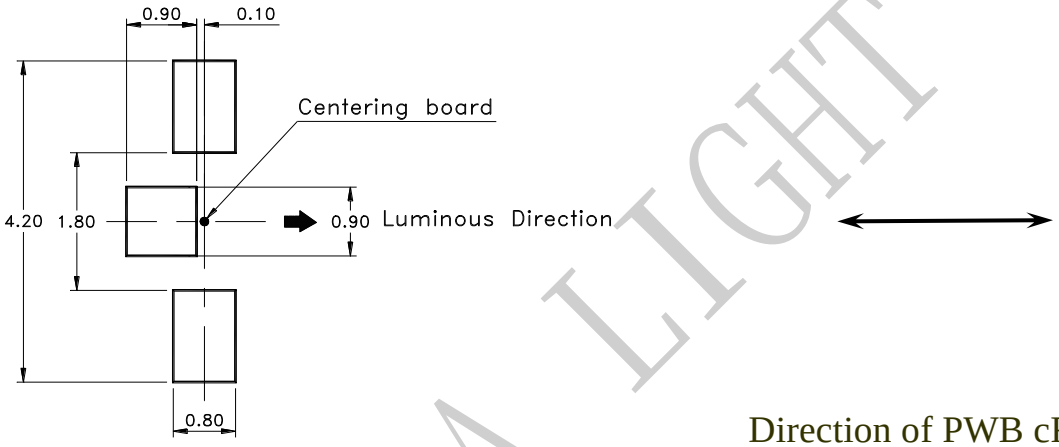


Notes:All dimensions are in millimeters.

- Cleaning

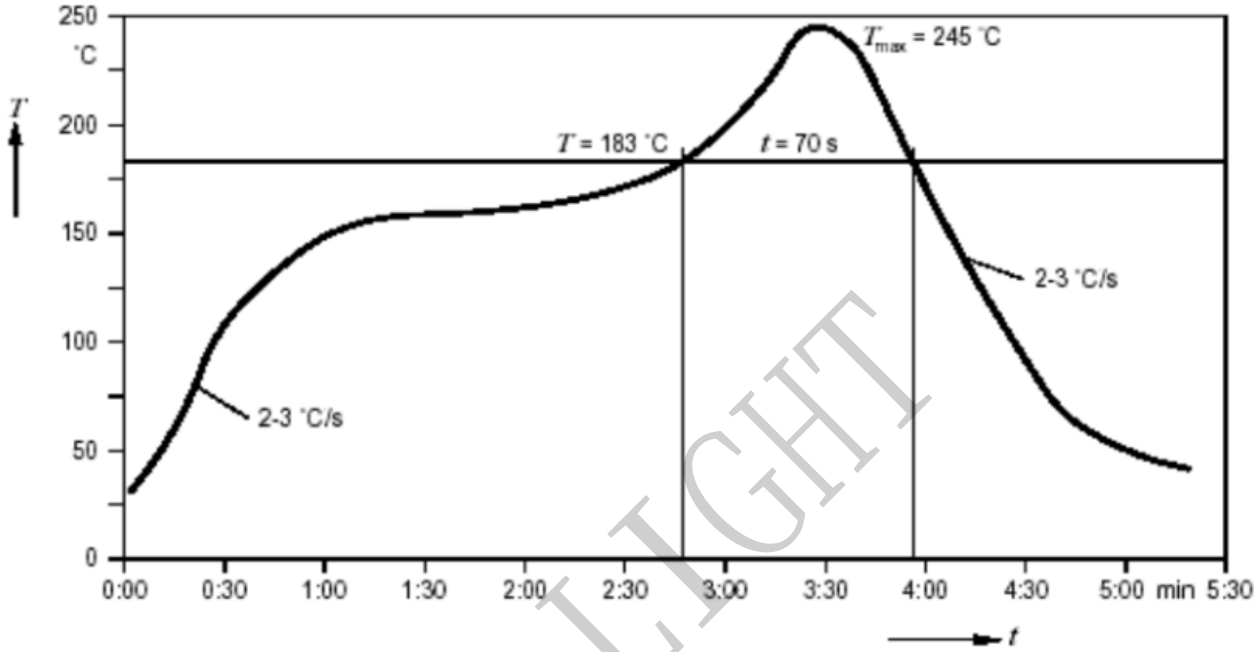
  ∗ If cleaning is required , use the following solutions for less than 1 minute and less than 40℃.
  ∗ Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
  ∗ Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

- Suggest Soldering Pad Dimensions

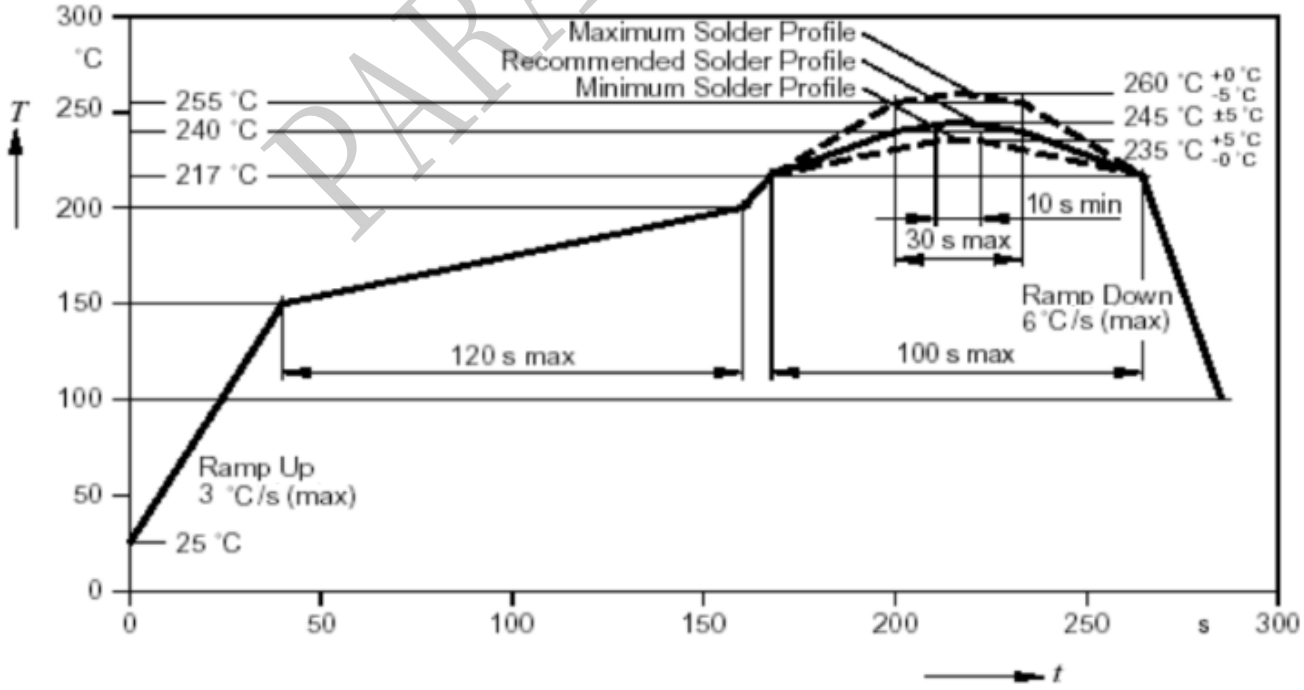


Direction of PWB cRed
and go to reflow furnace

- Suggest Sn/Pb IR Reflow Soldering Profile Condition:



- Suggest Pb-Free IR Reflow Soldering Profile Condition:



● CAUTIONS

1.Application limitation :

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application).Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage :

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5℃ for 24 hours.

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering :

Pre-heat 120~150 ℃, 120sec. MAX., Peak temperature : 240 ℃ Max. Soldering time : 10 sec Max.

Soldering Iron : (Not recommended)

Temperature 300 ℃ Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering :

Pre-heat 100 ℃ Max, Pre-heat time 60 sec. Max, Solder wave 260 ℃ Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

4. Lead-Free Soldering

For Reflow Soldering :

1、Pre-Heat Temp:150-180℃,120sec.Max.

2、Soldering Temp:Temperature Of Soldering Pot Over 230℃,40sec.Max.

3、Peak Temperature:260℃ ，5sec.

4、Reflow Repetition:2 Times Max.

5、Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

For Soldering Iron (Not Recommended) :

1、Iron Tip Temp:350℃ Max.

2、Soldering Iron:30w Max.

3、Soldering Time:3 Sec. Max. One Time.

For Dip Soldering :

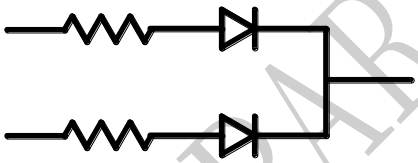
1、Pre-Heat Temp:150℃ Max. 120 Sec. Max.

2、Bath Temp:265℃ Max.

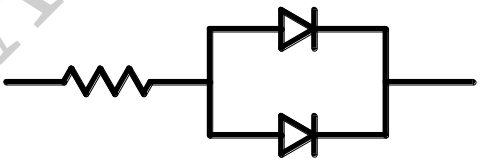
3、Dip Time:5 Sec. Max.

5. Drive Method

Circuit model A



Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED`s could be found due to the Vf-If characteristics of LED.